



THE DATASHEET OF CA3039



**OBSOLETE PRODUCT
NO RECOMMENDED REPLACEMENT
Call Central Applications 1-888-INTERSIL
or email: centapp@intersil.com**

Features

- Six Matched Diodes on a Common Substrate
- Excellent Reverse Recovery Time 1ns (Typ)
- V_F Match 5mV (Max)
- Low Capacitance $C_D = 0.65\text{pF}$ (Typ) at $V_R = -2\text{V}$

Applications

- Ultra-Fast Low Capacitance Matched Diodes for Applications in Communications and Switching Systems
- Balanced Modulators or Demodulators
- Ring Modulators
- High Speed Diode Gates
- Analog Switches

Description

The CA3039 consists of six ultra-fast, low capacitance diodes on a common monolithic substrate. Integrated circuit construction assures excellent static and dynamic matching of the diodes, making the array extremely useful for a wide variety of applications in communication and switching systems.

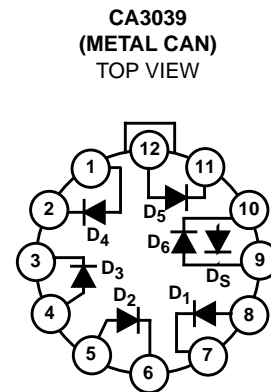
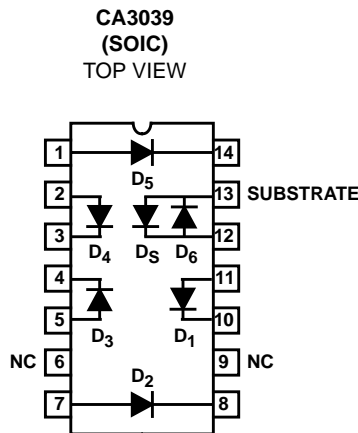
Five of the diodes are independently accessible, the sixth shares a common terminal with the substrate.

For applications such as balanced modulators or ring modulators where capacitive balance is important, the substrate should be returned to a DC potential which is significantly more negative (with respect to the active diodes) than the peak signal applied.

Part Number Information

PART NUMBER	TEMP. RANGE (°C)	PACKAGE	PKG. NO.
CA3039	-55 to 125	12 Pin Metal Can	T12.B
CA3039M	-55 to 125	14 Ld SOIC	M14.15
CA3039M96	-55 to 125	14 Ld SOIC Tape and Reel	M14.15

Pinouts



Typical Performance Curves

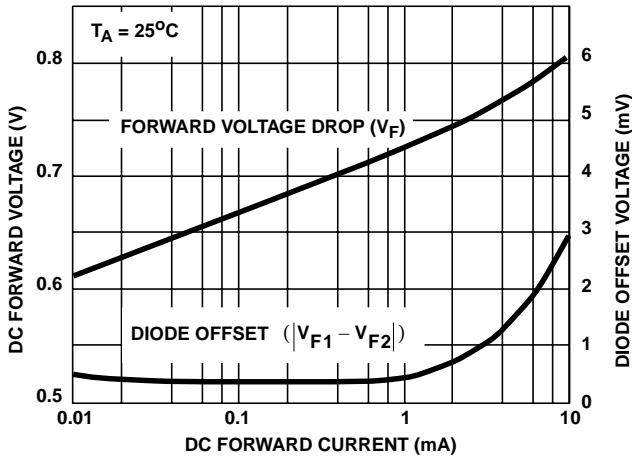


FIGURE 1. DC FORWARD VOLTAGE DROP (ANY DIODE) AND DIODE OFFSET VOLTAGE vs DC FORWARD CURRENT

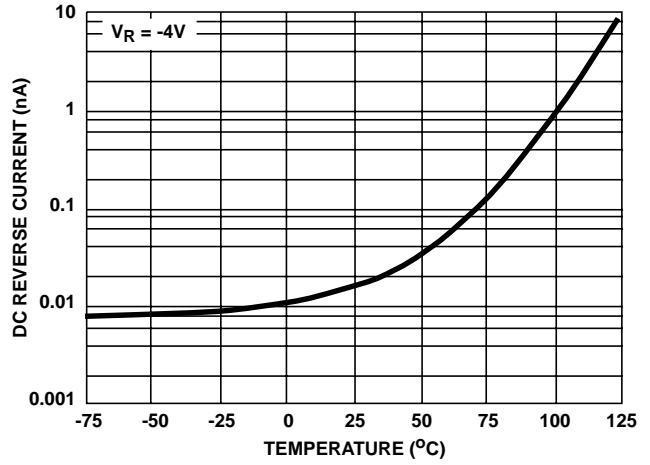


FIGURE 2. DC REVERSE (LEAKAGE) CURRENT ($D_1 - D_5$) vs TEMPERATURE

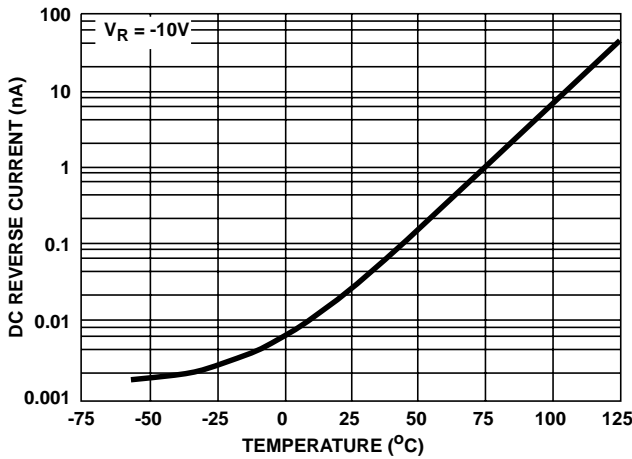


FIGURE 3. DC REVERSE (LEAKAGE) CURRENT BETWEEN D_1, D_2, D_3, D_4, D_5 AND SUBSTRATE vs TEMPERATURE

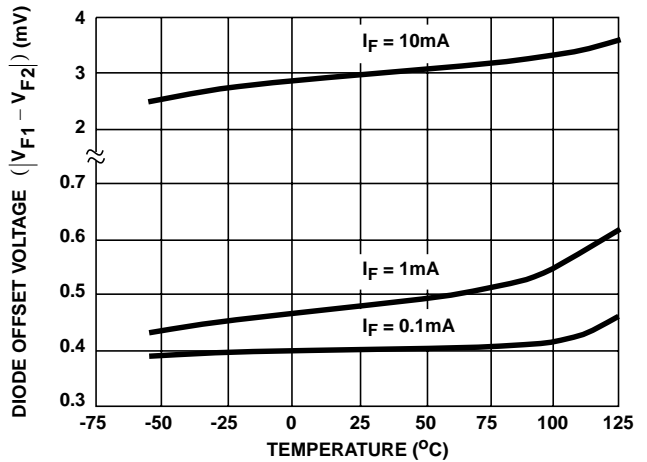


FIGURE 4. DIODE OFFSET VOLTAGE (ANY DIODE) vs TEMPERATURE

Typical Performance Curves (Continued)

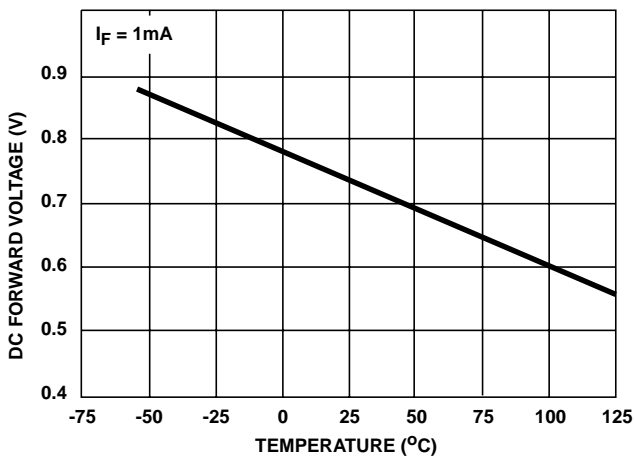


FIGURE 5. DC FORWARD VOLTAGE DROP (ANY DIODE) vs TEMPERATURE

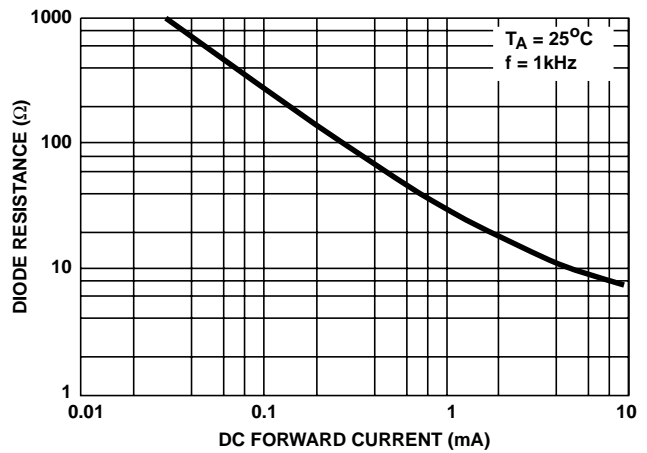


FIGURE 6. DIODE RESISTANCE (ANY DIODE) vs DC FORWARD CURRENT

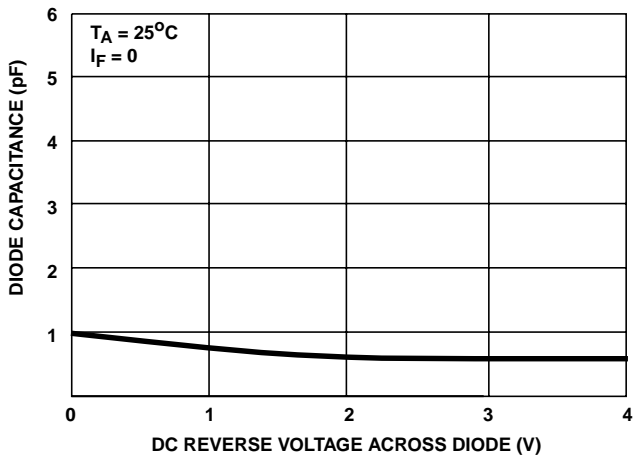


FIGURE 7. DIODE CAPACITANCE (D₁ - D₅) vs REVERSE VOLTAGE

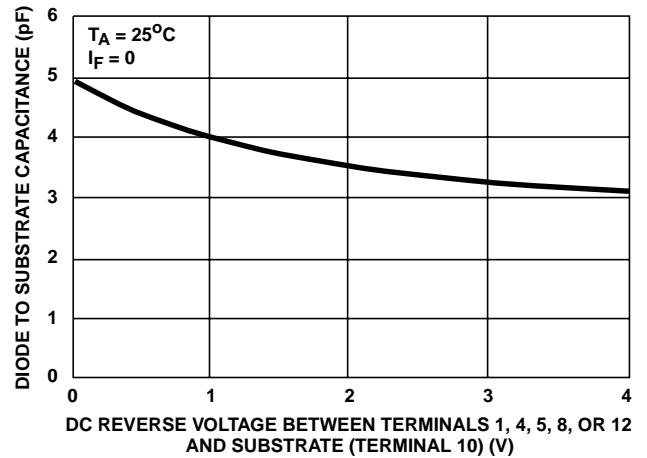


FIGURE 8. DIODE-TO-SUBSTRATE CAPACITANCE vs REVERSE VOLTAGE

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